

### DF005S thru DF10S

# SURFACE MOUNT GLASS PASSIVATED BRIDGE RECTIFIERS

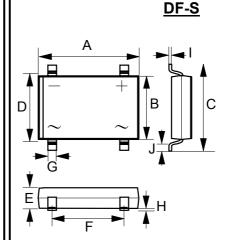
REVERSE VOLTAGE – 50 to 1000 Volts FORWARD CURRENT – 1.0 Ampere

#### **FEATURES**

- Rating to 1000V PRV
- Ideal for printed circuit board
- · Low forward voltage drop high current capability
- Reliable low cost construction utilizing molded plastic technique
- UL recognized file # E95060

#### **MECHANICAL DATA**

- Case Material: molding compound, UL flammability classification 94V-0
- · Polarity: As marked on the body
- Mounting Position: Any
- Weight: 360mg (Approximate)



DF-S					
DIM	MIN MA				
Α	8.20	8.50			
В	6.20	6.50			
С	9.80	10.30			
D	7.40	7.90			
Е	2.40	2.60			
F	5.00	5.20			
G	1.00				
Н	.076	.330			
ı	.220	.300			
J	1.02	1.53			
All dimension in millimeter					

#### **MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS**

Ratings at 25°C ambient temperature unless otherwise specified.

#### **ABSOLUTE RATINGS**

PARAMETER	SYMBOL	DF005S	DF01S	DF02S	DF04S	DF06S	DF08S	DF10S	UNIT
Device marking code	Note	DF005S	DF01S	DF02S	DF04S	DF06S	DF08S	DF10S	
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Maximum DC blocking voltage	$V_{DC}$	50	100	200	400	600	800	1000	V
Average rectified output current per device @T <sub>A</sub> = 40°C	I <sub>(AV)</sub>	1.0					Α		
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC METHOD)	I <sub>FSM</sub>	50					Α		
Peak forward surge current 1ms single half sine-wave superimposed on rated load (JEDEC METHOD)	I <sub>FSM</sub>	100					Α		
I <sup>2</sup> t rating for fusing ( t < 8.3ms)	l²t	10.4				A <sup>2</sup> S			
Operating and storage temperature range	T <sub>J</sub> ,T <sub>STG</sub>	-55 to +150					°C		

#### STATIC ELECTRICAL CHARACTERISTICS

PARAMETER	TEST CO	NDITION	SYMBOL	MAX.	UNIT
Forward voltage	I <sub>F</sub> = 1.0A	T <sub>J</sub> = 25°C	$V_{F}$	1.1	V
Leakage current	V <sub>R</sub> at rated	T <sub>J</sub> = 25°C T <sub>J</sub> = 125°C	I <sub>R</sub>	10 500	uA
Typical junction capacita	INCE (Note 1)		CJ	25	pF

#### THERMAL CHARACTERISTICS

PARAMETER	SYMBOL	TYP.	UNIT
	RthJ <sub>A</sub>	40	
Typical thermal resistance (Note 2)	RthJ <sub>c</sub>	8	°C/W
	RthJ∟	20	

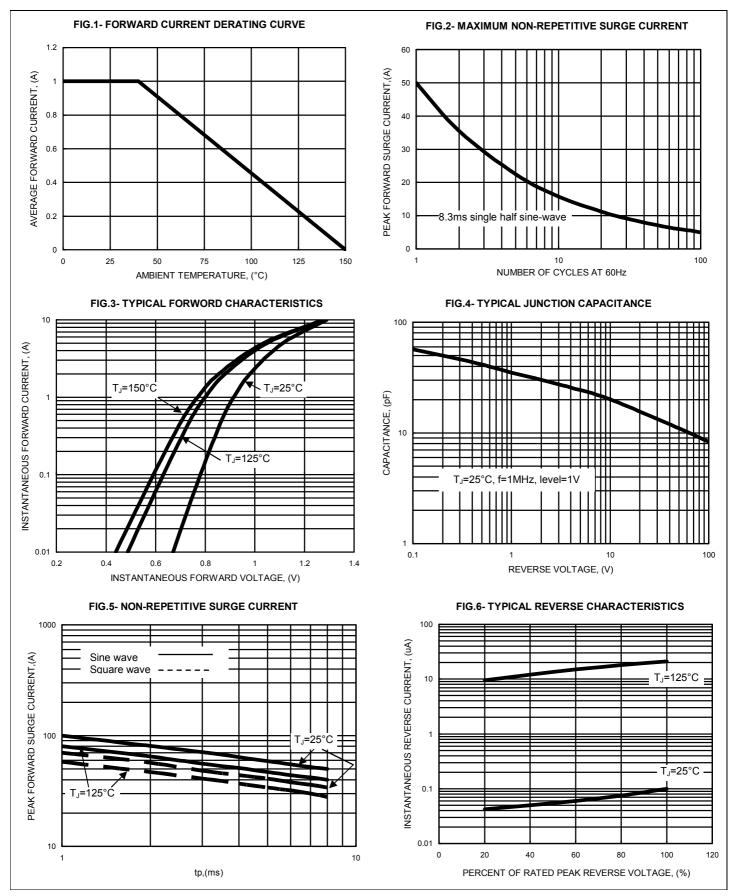
(1) Measured at 1.0MHz and applied reverse voltage of 4.0V DC

(2) Thermal resistance junction to ambient, case and lead in accordance with JESD-51. Unit mounted on P.C.B with 0.5 x 0.5" (13 x 13 mm) copper pad per pin.

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# RATING AND CHARACTERISTIC CURVES DF005S thru DF10S







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